

Features

- ESD/Surge Protection for 1 Line with Bi-directional
- Provide ESD protection for each line to
IEC 61000-4-2 (ESD) $\pm 30\text{kV}$ (air / contact)
IEC 61000-4-4 (EFT) 80A (5/50ns)
IEC 61000-4-5 (Lightning) 100A (8/20 μs)
- For operating voltage of 5.0V and below
- **1.6mm x 1.0mm DFN package** saves board space
- High surge protection
- Fast turn-on and low clamping voltage
- Solid-state silicon-avalanche and active circuit triggering technology
- **Green part**

Applications

- Vbat Pin for Mobile Device
- Power Line Protection
- Audio Protection
- Mobile Phones
- Hand Held Portable Applications

Description

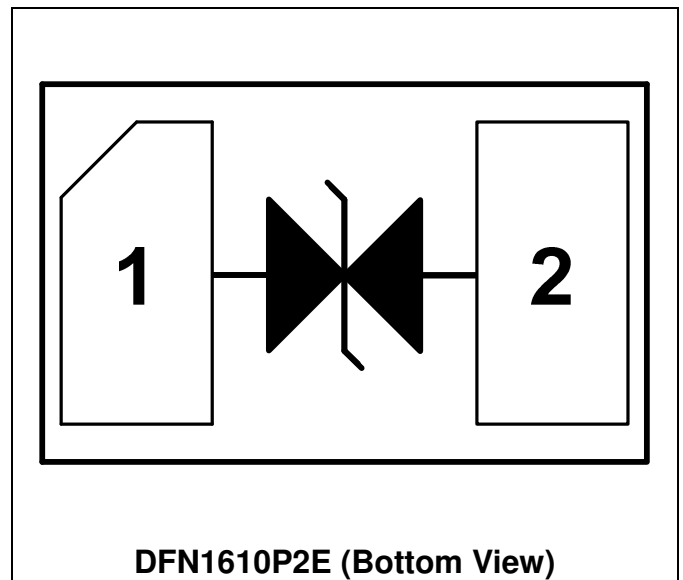
AZ3205-01F is a design which includes a bi-directional surge rated clamping cell to protect one power line, or one control line, or one low speed data line in an electronic system. The AZ3205-01F has been specifically designed to protect sensitive components which are connected to power and control lines from over-voltage damage caused by Electrostatic Discharging (ESD), Electrical Fast Transients (EFT), Lightning, and Cable Discharge Event (CDE).

AZ3205-01F is a unique design which includes proprietary clamping cell in a single package. During transient conditions, the proprietary clamping cell prevents over-voltage on the power line or control/data lines, protecting any downstream components.

AZ3205-01F is bi-directional and may be used on lines where the signal swings above and below ground.

AZ3205-01F may be used to meet the ESD immunity requirements of IEC 61000-4-2, Level 4 ($\pm 15\text{kV}$ air, $\pm 8\text{kV}$ contact discharge).

Circuit Diagram / Pin Configuration





SPECIFICATIONS

ABSOLUTE MAXIMUM RATINGS			
PARAMETER	SYMBOL	RATING	UNITS
Peak Pulse Current	I_{PP-1} (Note 1)	100	A
	I_{PP-2} (Note 2)	80	
Operating Supply Voltage	V_{DC}	± 5.5	V
ESD per IEC 61000-4-2 (Air)	V_{ESD-1}	± 30	kV
ESD per IEC 61000-4-2 (Contact)	V_{ESD-2}	± 30	
Lead Soldering Temperature	T_{SOL}	260 (10 sec.)	$^{\circ}C$
Operating Temperature	T_{OP}	-55 to +85	$^{\circ}C$
Storage Temperature	T_{STO}	-55 to +150	$^{\circ}C$

ELECTRICAL CHARACTERISTICS						
PARAMETER	SYMBOL	CONDITIONS	MINI	TYP	MAX	UNITS
Reverse Stand-Off Voltage	V_{RWM}	$T=25^{\circ}C$.	-5.0		5.0	V
Reverse Leakage Current	I_{Leak}	$V_{RWM} = \pm 5.0V, T=25^{\circ}C$.			1	μA
Reverse Breakdown Voltage	V_{BV}	$I_{BV} = 1mA, T=25^{\circ}C$.	6.0		9.0	V
Surge Clamping Voltage (Note 1)	V_{CL}	$I_{PP} = 50A, t_p=8/20\mu s, T=25^{\circ}C$.		8		V
		$I_{PP} = 100A, t_p=8/20\mu s, T=25^{\circ}C$.		11.5		
ESD Clamping Voltage (Note 3)	V_{clamp}	IEC 61000-4-2 +8kV ($I_{TLP} = 16A$), Contact mode, $T = 25^{\circ}C$.		6.0		V
Channel Input Capacitance	C_{IN}	$V_R = 0V, f = 1MHz, T=25^{\circ}C$.		140	200	pF

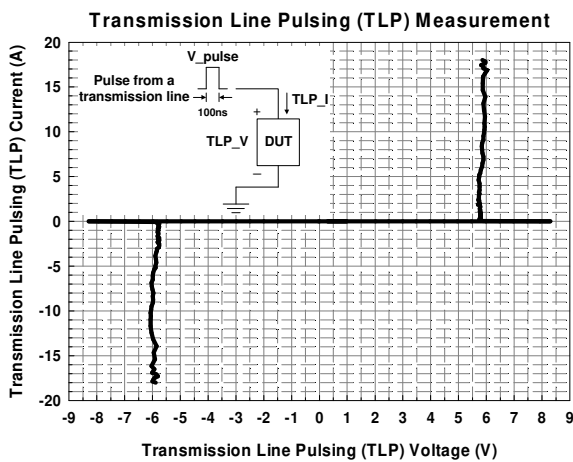
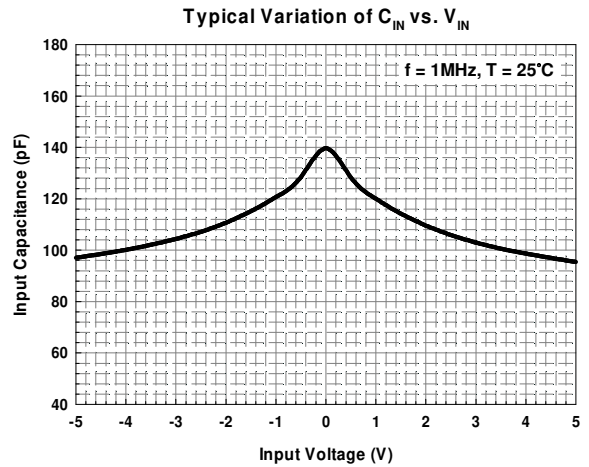
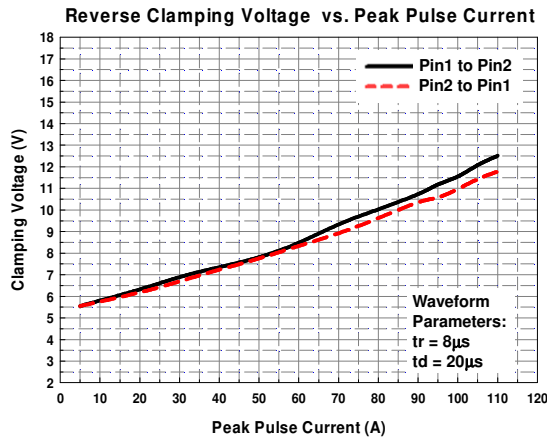
Note 1: The Peak Pulse Current measured conditions: $t_p = 8/20\mu s$, 2Ω source impedance.

Note 2: The Peak Pulse Current measured conditions: $t_p = 8/20\mu s$, 42Ω source impedance.

Note 3: ESD Clamping Voltage was measured by Transmission Line Pulsing (TLP) System.

TLP conditions: $Z_0 = 50\Omega$, $t_p = 100ns$, $t_r = 1ns$.

Typical Characteristics



Applications Information

The AZ3205-01F is designed to protect one line against system ESD/EFT/Lightning pulses by clamping them to an acceptable reference. It provides bi-directional protection.

The usage of the AZ3205-01F is shown in Fig. 1. Protected line, such as data line, control line, or power line, is connected at pin 1. The pin 2 is connected to a ground plane on the board. In order to minimize parasitic inductance in the board traces, all path lengths connected to the pins of AZ3205-01F should be kept as short as possible.

In order to obtain enough suppression of ESD induced transient, good circuit board is critical. Thus, the following guidelines are recommended:

- Minimize the path length between the protected lines and the AZ3205-01F.
- Place the AZ3205-01F near the input terminals or connectors to restrict transient coupling.
- The ESD current return path to ground should be kept as short as possible.
- Use ground planes whenever possible.
- NEVER route critical signals near board edges and near the lines which the ESD transient easily injects to.

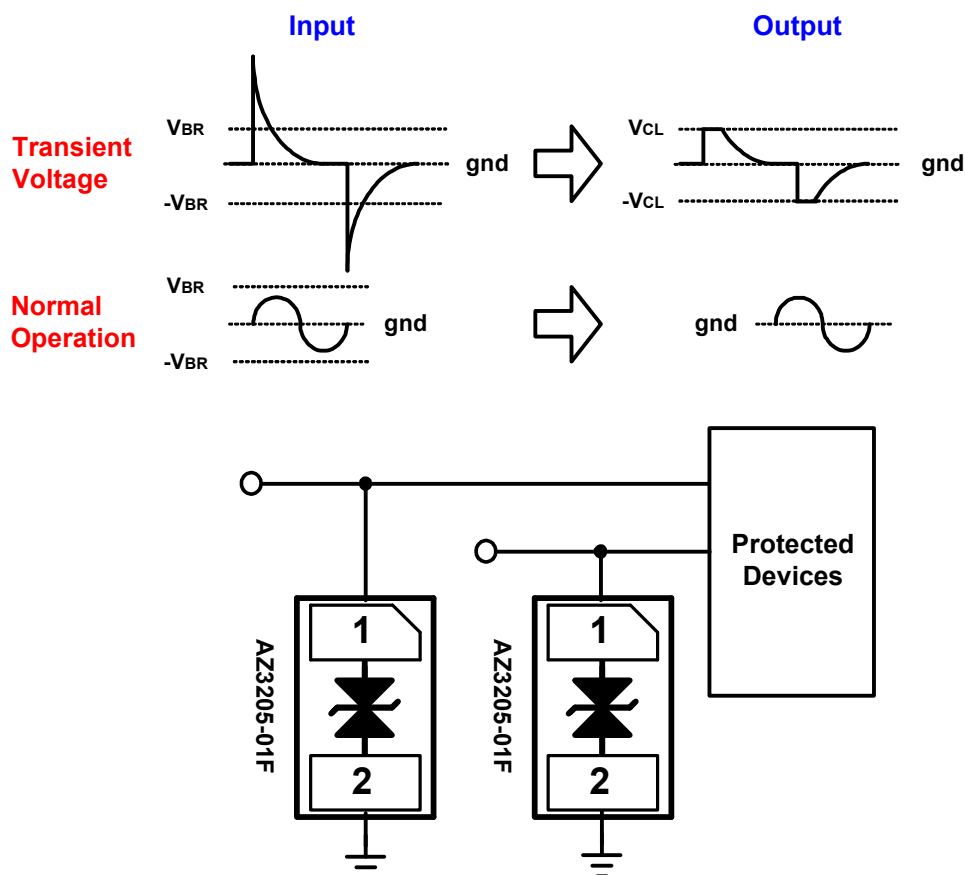
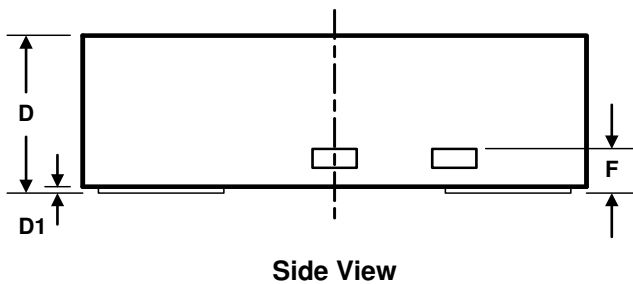
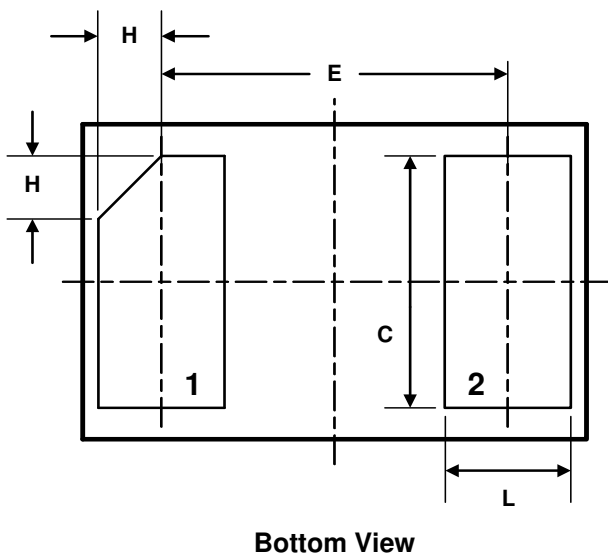
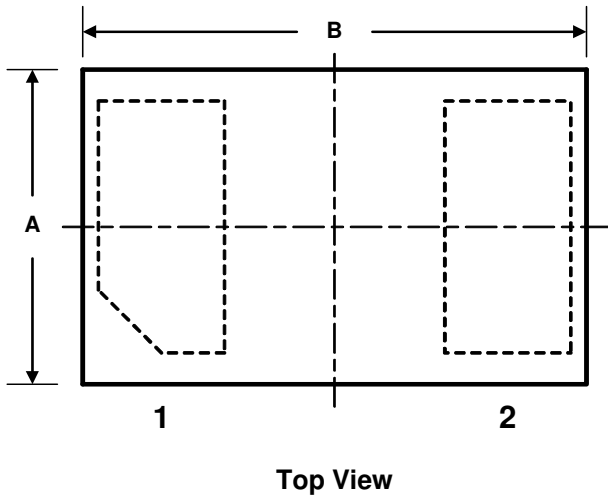


Fig. 1 ESD protection scheme by using AZ3205-01F.

Mechanical Details

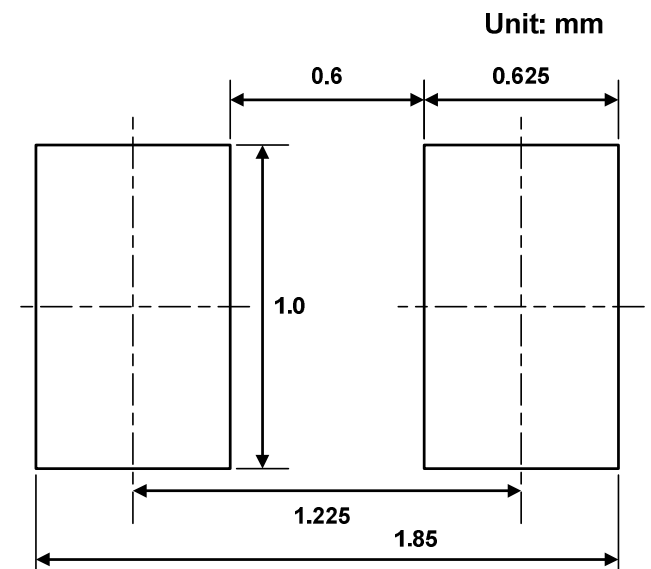
DFN1610P2E PACKAGE DIAGRAMS



PACKAGE DIMENSIONS

SYMBOL	Millimeter		
	Min.	Typ.	Max.
A	0.95	1.00	1.05
B	1.55	1.60	1.65
C	0.75	0.80	0.85
D	0.45	0.50	0.55
D1	-	0.02	0.05
E	1.10BSC		
F	0.10	0.15	0.20
H	0.15	0.20	0.25
L	0.35	0.40	0.45

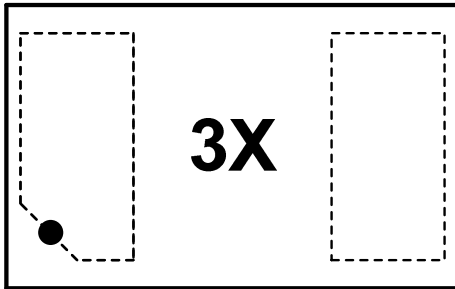
LAND LAYOUT



Notes:

This LAND LAYOUT is for reference purposes only. Please consult your manufacturing partners to ensure your company's PCB design guidelines are met.

MARKING CODE



Top View

Part Number	Marking Code
AZ3205-01F.R7G (Green Part)	3X

Note. Green means Pb-free, RoHS, and Halogen free compliant.

3 = Device Code
X = Date Code

Ordering Information

PN#	Material	Type	Reel size	MOQ	MOQ/internal box	MOQ/carton
AZ3205-01F.R7G	Green	T/R	7 inch	3,000/reel	4 reels = 12,000/box	6 boxes = 72,000/carton

Revision History

Revision	Modification Description
Revision 2016/03/15	Preliminary Release.
Revision 2017/05/16	Formal Release.